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# 3SK322

Silicon N-Channel Dual Gate MOS FET

# HITACHI

ADE-208-712A (Z)  
2nd. Edition  
Dec. 1998

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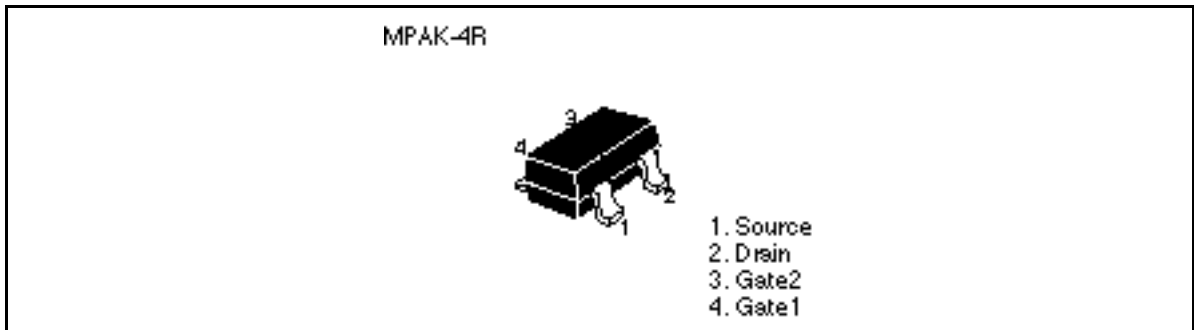
## Application

UHF / VHF RF amplifier

## Features

- Low noise figure.  
NF = 1.0 dB typ. at f = 200 MHz
- Capable of low voltage operation
- Provide mini mold packages; MPAK-4R(SOT-143 var.)

## Outline



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## 3SK322

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### Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DS}$	12	V
Gate 1 to source voltage	$V_{G1S}$	±8	V
Gate 2 to source voltage	$V_{G2S}$	±8	V
Drain current	$I_D$	25	mA
Channel power dissipation	Pch	150	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

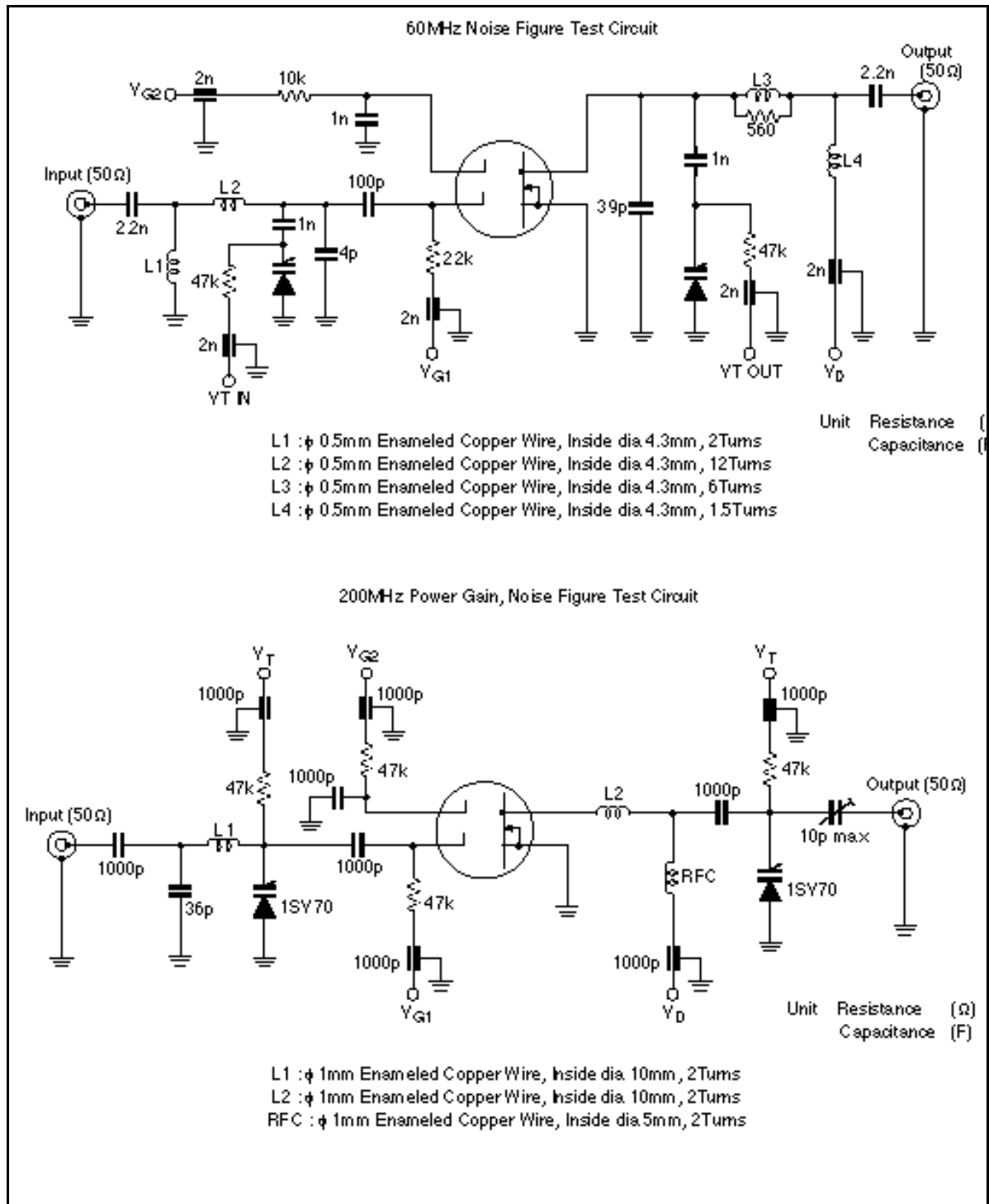
Attention: This device is very sensitive to electro static discharge.  
It is recommended to adopt appropriate cautions when handling this transistor.

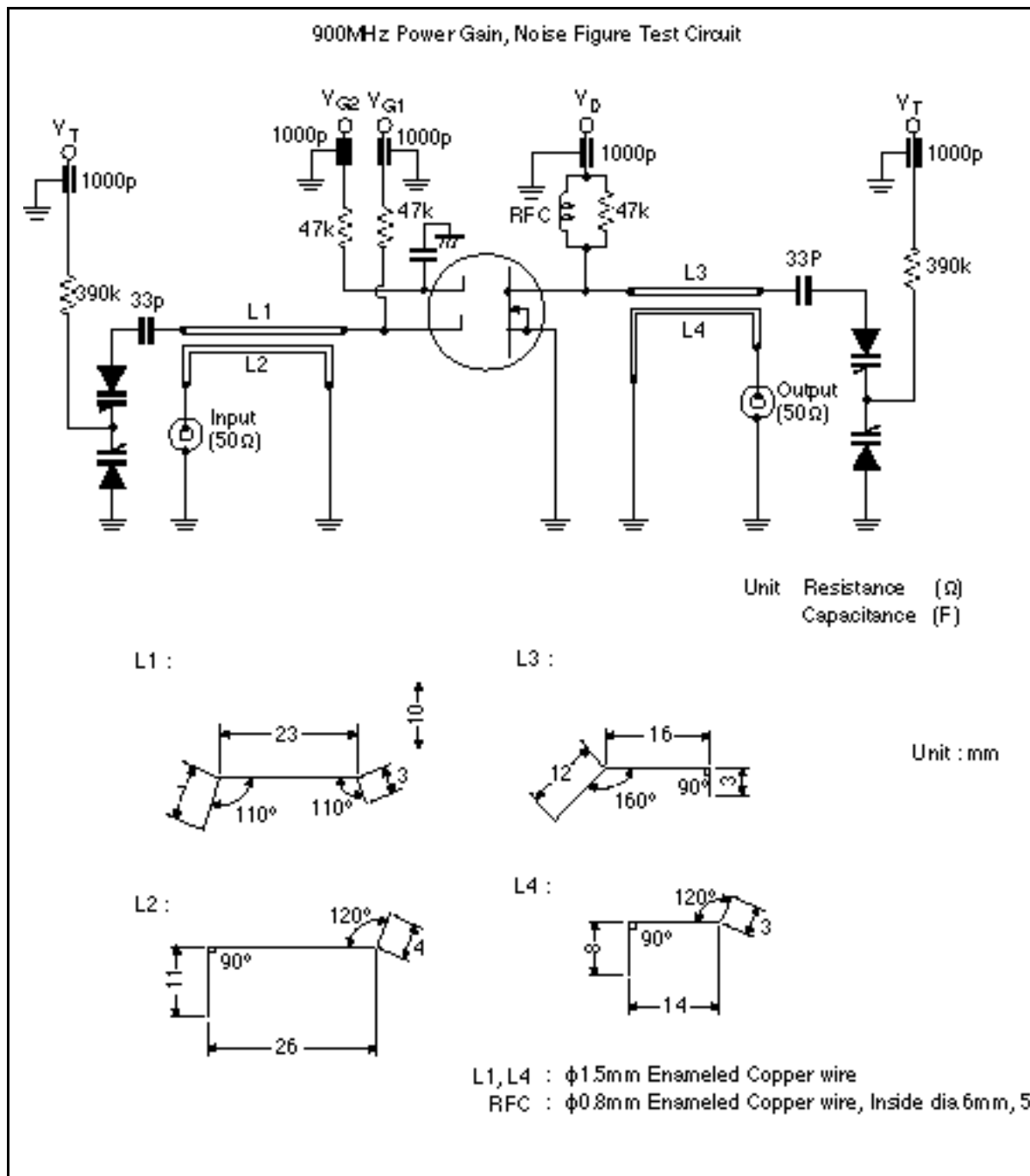
## Electrical Characteristics (Ta = 25°C)

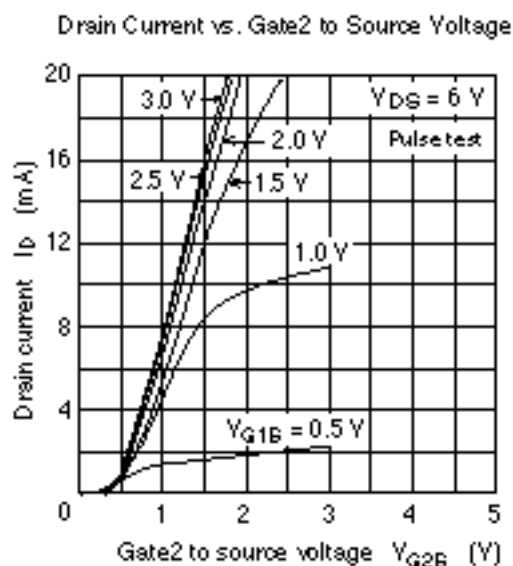
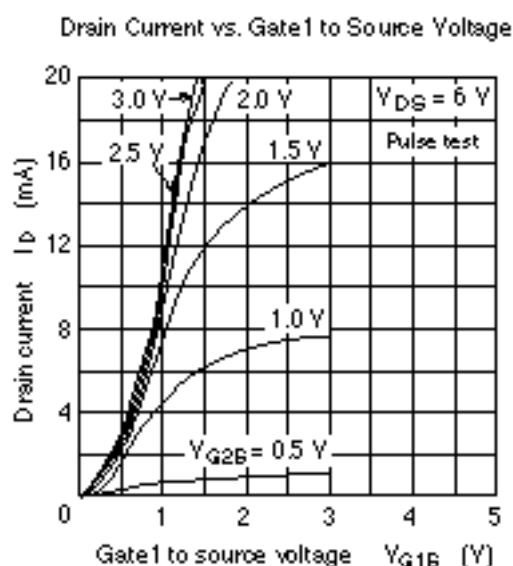
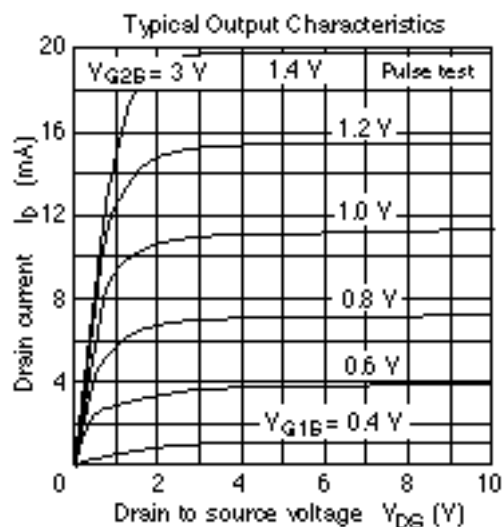
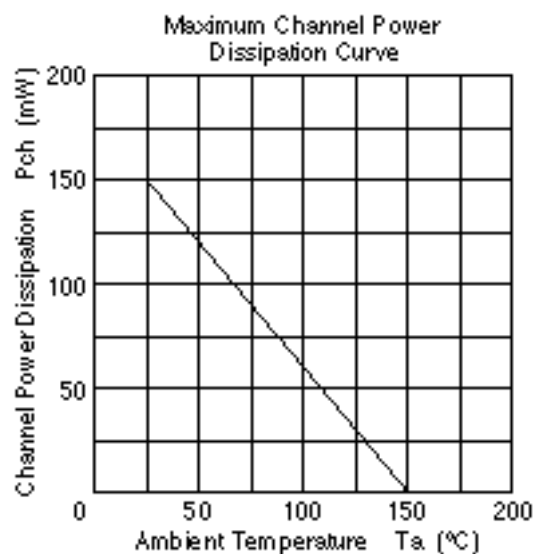
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSX}$	12	—	—	V	$I_D = 200 \mu A$ , $V_{G1S} = -3 V$ , $V_{G2S} = -3 V$
Gate 1 to source breakdown voltage	$V_{(BR)G1SS}$	$\pm 8$	—	—	V	$I_{G1} = \pm 10 \mu A$ , $V_{G2S} = V_{DS} = 0$
Gate 2 to source breakdown voltage	$V_{(BR)G2SS}$	$\pm 8$	—	—	V	$I_{G2} = \pm 10 \mu A$ , $V_{G1S} = V_{DS} = 0$
Gate 1 cutoff current	$I_{G1SS}$	—	—	$\pm 100$	nA	$V_{G1S} = \pm 6 V$ , $V_{G2S} = V_{DS} = 0$
Gate 2 cutoff current	$I_{G2SS}$	—	—	$\pm 100$	nA	$V_{G2S} = \pm 6 V$ , $V_{G1S} = V_{DS} = 0$
Drain current	$I_{DS(on)}$	0.5	—	10	mA	$V_{DS} = 6 V$ , $V_{G1S} = 0.75 V$ , $V_{G2S} = 3 V$
Gate 1 to source cutoff voltage	$V_{G1S(off)}$	0	—	+1.0	V	$V_{DS} = 10 V$ , $V_{G2S} = 3 V$ , $I_D = 100 \mu A$
Gate 2 to source cutoff voltage	$V_{G2S(off)}$	0	—	+1.0	V	$V_{DS} = 10 V$ , $V_{G1S} = 3 V$ , $I_D = 100 \mu A$
Forward transfer admittance	$ y_{fs} $	16	20	—	mS	$V_{DS} = 6 V$ , $V_{G2S} = 3 V$ , $I_D = 10 mA$ , $f = 1 kHz$
Input capacitance	$C_{iss}$	2.4	2.9	3.4	pF	$V_{DS} = 6 V$ , $V_{G2S} = 3 V$ , $I_D = 10 mA$ , $f = 1 MHz$
Output capacitance	$C_{oss}$	0.8	1.0	1.4	pF	
Reverse transfer capacitance	$C_{rss}$	—	0.023	0.04	pF	
Power gain	PG	22	25	—	dB	$V_{DS} = 6 V$ , $V_{G2S} = 3 V$ , $I_D = 10 mA$ , $f = 200 MHz$
Noise figure	NF	—	1.0	1.8	dB	
Power gain	PG	12	15	—	dB	$V_{DS} = 6 V$ , $V_{G2S} = 3 V$ , $I_D = 10 mA$ , $f = 900 MHz$
Noise figure	NF	—	3.2	4.5	dB	
Noise figure	NF	—	2.8	3.5	dB	$V_{DS} = 6 V$ , $V_{G2S} = 3 V$ , $I_D = 10 mA$ , $f = 60 MHz$

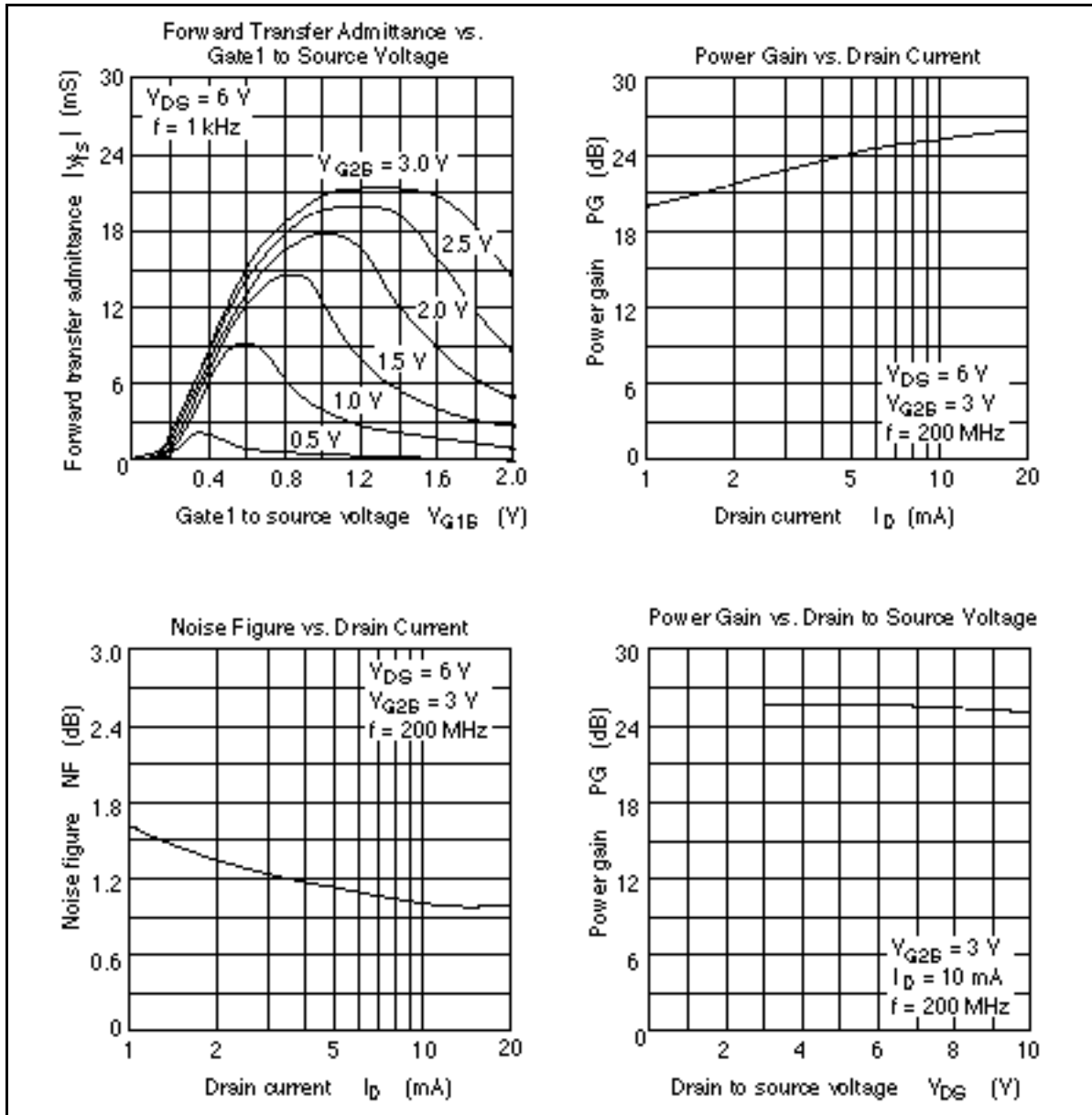
Note: Marking is "ZW—"

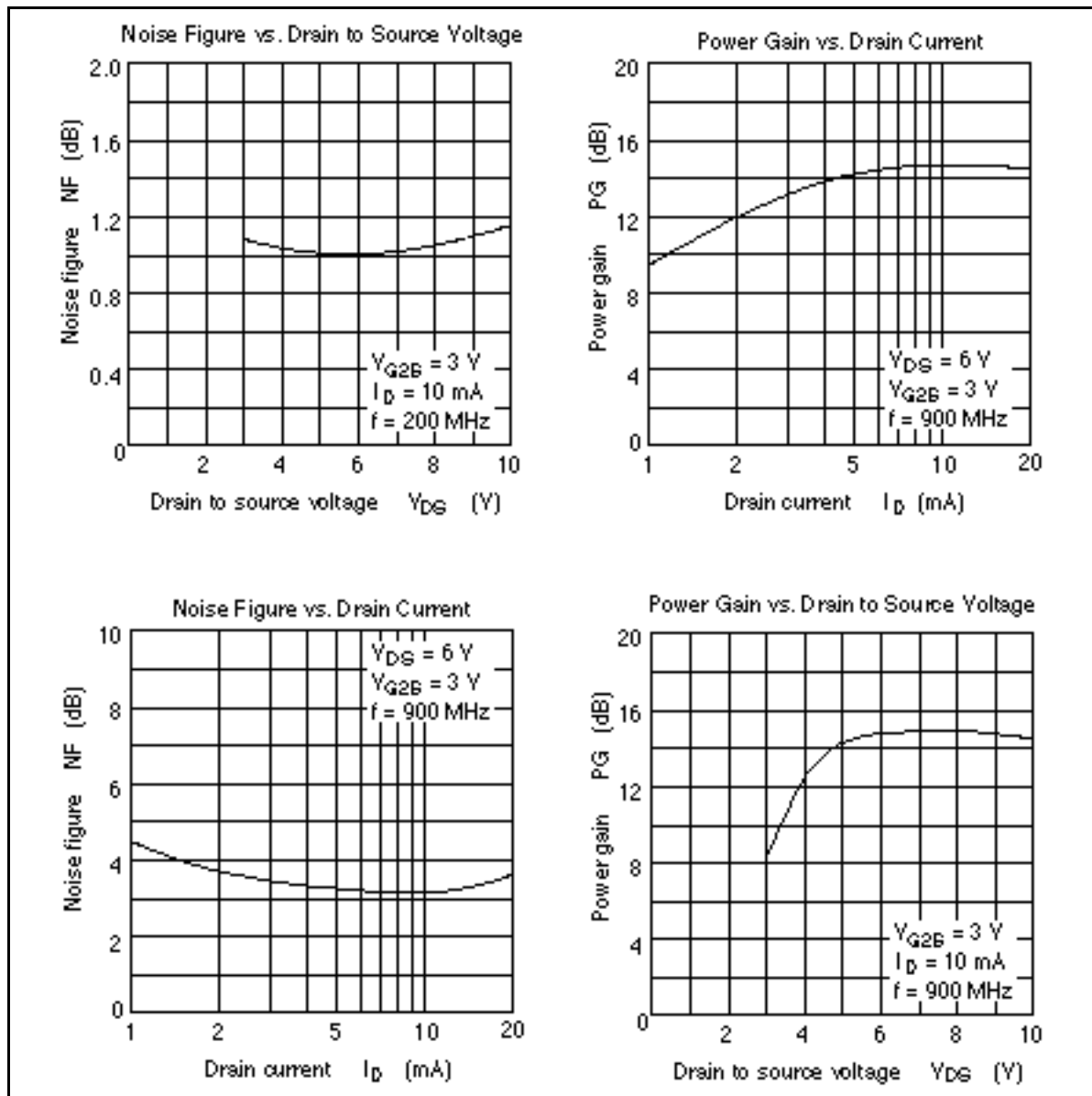
Main Characteristics



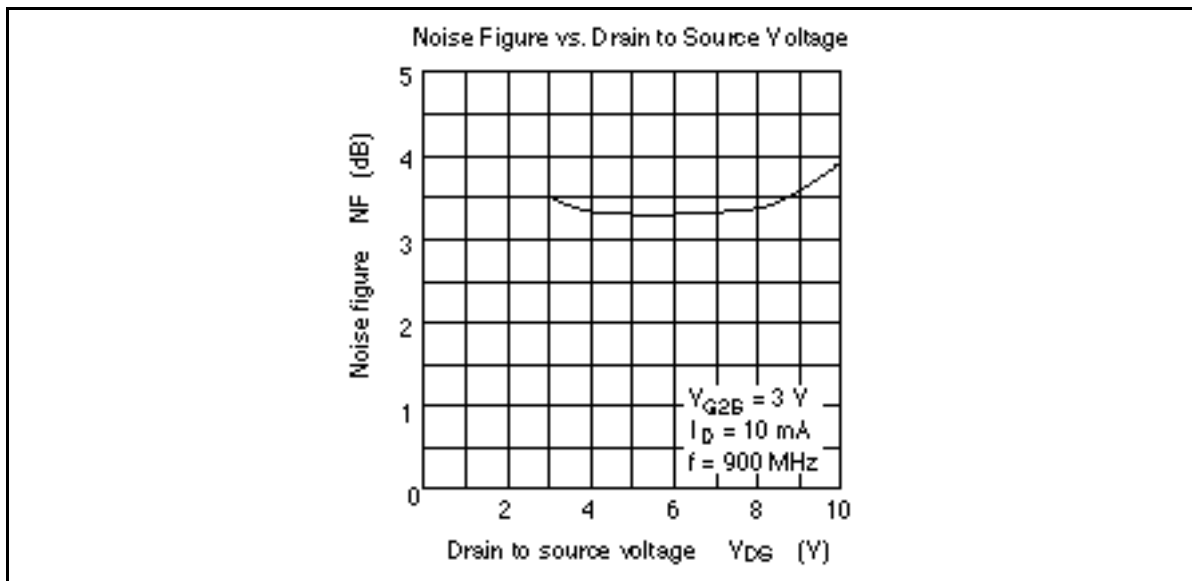


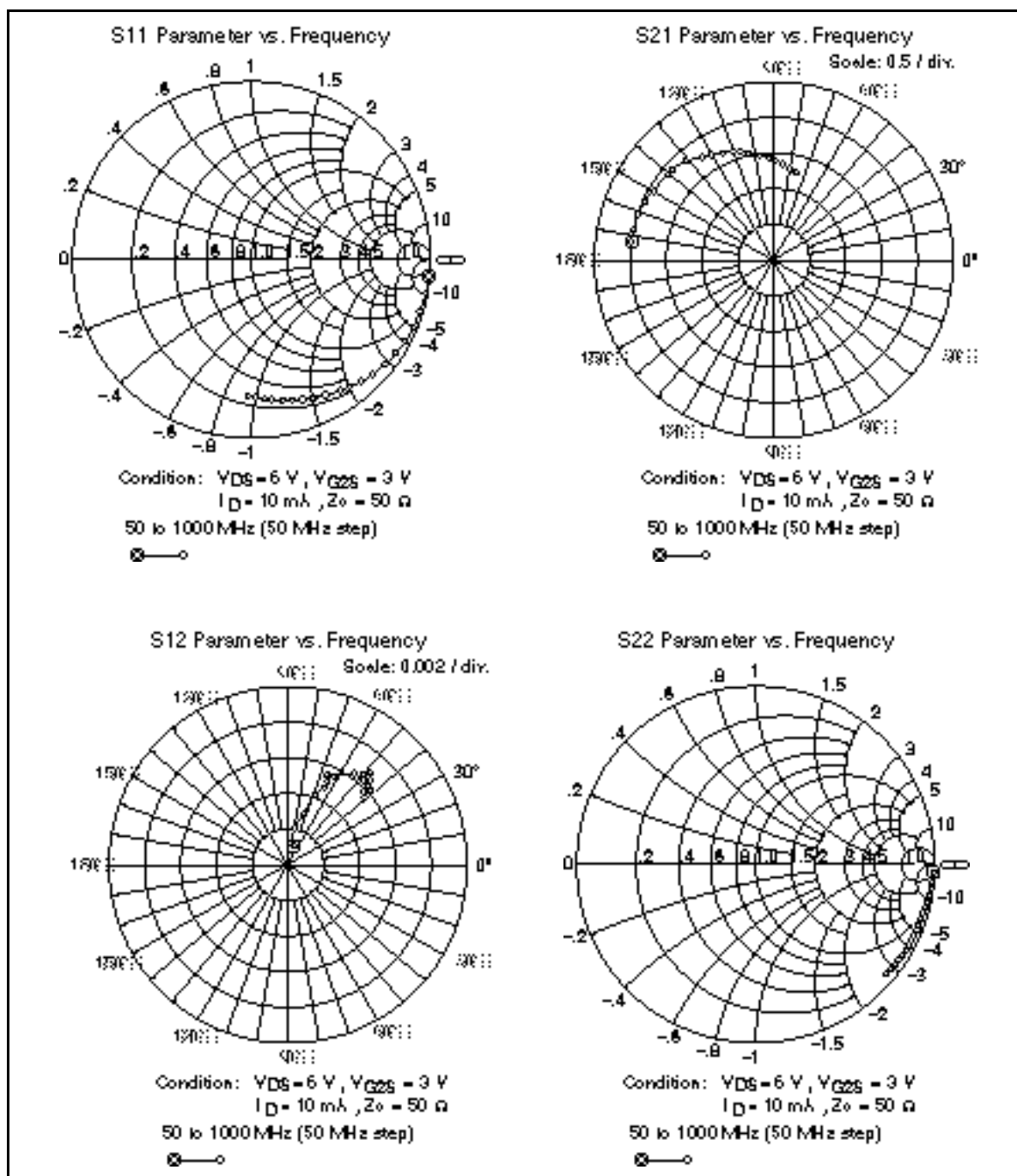












**S Parameter** ( $V_{DS} = 6 \text{ V}$ ,  $V_{G2S} = 3 \text{ V}$ ,  $I_D = 10 \text{ mA}$ ,  $Z_0 = 50 \text{ } \Omega$ )

Freq. (MHz)	S11		S21		S12		S22	
	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.
50	0.994	-5.8	2.04	173.6	0.00116	76.9	0.993	-2.2
100	0.993	-11.0	2.02	167.4	0.00132	85.7	0.993	-4.5
150	0.986	-16.8	2.00	161.5	0.00229	78.2	0.991	-6.4
200	0.980	-22.5	1.98	155.5	0.00313	73.5	0.990	-8.5
250	0.973	-27.8	1.94	149.6	0.00427	68.7	0.987	-10.5
300	0.950	-33.0	1.90	142.6	0.00473	63.9	0.985	-12.5
350	0.936	-38.3	1.86	137.1	0.00536	64.3	0.982	-14.4
400	0.924	-43.4	1.83	131.6	0.00561	64.5	0.979	-16.2
450	0.912	-48.0	1.77	126.8	0.00562	60.9	0.975	-18.2
500	0.893	-52.5	1.71	121.0	0.00640	53.5	0.971	-20.2
550	0.874	-57.3	1.67	115.5	0.00638	49.3	0.967	-22.0
600	0.859	-62.0	1.64	111.1	0.00647	49.0	0.964	-23.9
650	0.846	-66.1	1.58	106.7	0.00667	50.2	0.960	-25.8
700	0.829	-69.8	1.50	102.1	0.00694	49.3	0.955	-27.6
750	0.810	-74.2	1.46	97.1	0.00661	46.6	0.952	-29.4
800	0.802	-78.0	1.44	92.7	0.00618	43.7	0.948	-31.2
850	0.791	-81.6	1.38	88.9	0.00622	44.7	0.944	-33.2
900	0.778	-84.6	1.34	84.2	0.00615	43.6	0.940	-35.1
950	0.756	-88.5	1.30	80.2	0.00576	45.1	0.935	-36.8
1000	0.751	-92.2	1.26	75.9	0.00562	40.7	0.932	-38.5

**Cautions**

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